



General Description

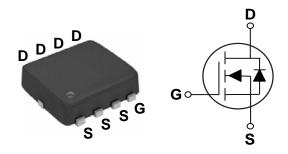
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

| BV _{DSS} | R _{DS(ON)} | Ι _D |
|-------------------|---------------------|----------------|
| 100 V | 10.3 mΩ | 48 A |

Features

- 100V, 48A, $R_{DS(ON)}$ =10.3m Ω @ V_{GS} =10V
- · Improved dv/dt capability
- · Fast switching
- · Green Device Available

PPAK3X3 Pin Configuration



Applications

- Networking
- · Load Switch
- LED applications

| Symbol | mbol Parameter Rating | | Units |
|------------------|--|----------------|-------|
| V_{DS} | Drain-Source Voltage | 100 | V |
| V_{GS} | Gate-Source Voltage | ±20 | V |
| 1 | Drain Current - Continuous (T _C =25°C) | 48 | Α |
| I _D | Drain Current - Continuous (T _C =100°C) | 30 | Α |
| I _{DM} | Drain Current - Pulsed (NOTE 1) | 192 | Α |
| EAS | Single Pulse Avalanche Energy (NOTE 2) | 115 | mJ |
| IAS | Single Pulse Avalanche Current (NOTE 2) | 48 | Α |
| P_{D} | Power Dissipation (T _C =25°C) | 61 | W |
| FD | Power Dissipation - Derate above 25°C | 0.49 | W/°C |
| T_J | Operating Junction Temperature Range | -50 to 150 | °C |
| T _{STG} | Storage Temperature Range | -50 to 150 | °C |
| Marking Code | | NM010 / 0982BZ | |

| Thermal Characteristics | | | | | |
|----------------------------|--|--|------|------|--|
| Symbol Parameter Typ. Max. | | | Max. | Unit | |
| $R_{\theta JA}$ | Thermal Resistance Junction to Ambient | | 62 | °C/W | |
| $R_{	heta JC}$ | Thermal Resistance Junction to Case | | 2.04 | °C/W | |





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-------------------|--------------------------------|---|------|------|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V_{GS} =0V , I_D =250uA | 100 | | | V |
| I _{DSS} | IDrain-Source Leakage Current | V_{DS} =80V , V_{GS} =0V , T_J =25 $^{\circ}$ C | | | 1 | uA |
| | | V_{DS} =80V , V_{GS} =0V , T_J =85 $^{\circ}$ C | | | 10 | uA |
| I _{GSS} | Gate-Source Leakage Current | V_{GS} =±20V , V_{DS} =0V | | | ±100 | nA |

On Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---------------------|------------------------------------|---|------|------|------|------|
| R _{DS(ON)} | IStatic Drain-Source On-Resistance | V_{GS} =10V , I_D =20A | | 8.6 | 10.3 | mΩ |
| | | V _{GS} =4.5V , I _D =15A | | 11.5 | 15 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250uA$ | 1.2 | 1.5 | 2.5 | V |
| gfs | Forward Transconductance | V_{DS} =10V , I_{D} =3A | | 10 | | S |

Dynamic and switching Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|------------------|----------------------------------|---|------|------|------|------|
| Q_g | Total Gate Charge (NOTE 3 \ 4) | | | 26.1 | 39 | |
| Q_{gs} | Gate-Source Charge (NOTE 3 \ 4) | V_{DS} =50V , V_{GS} =10V , I_{D} =10A | | 6.5 | 10 | nC |
| Q_{gd} | Gate-Drain Charge (NOTE 3 \ 4) | | | 5.3 | 8 | |
| $T_{d(on)}$ | Turn-On Delay Time (NOTE 3 \ 4) | V_{DD} =50V , V_{GS} =10V , R_{G} =6 Ω , I_{D} =1A | | 14.2 | 28 | |
| T _r | Rise Time (NOTE 3 \ 4) | | | 20.8 | 42 | nS |
| $T_{d(off)}$ | Turn-Off Delay Time (NOTE 3 \ 4) | | | 42 | 84 | 113 |
| T_f | Fall Time (NOTE 3 \ 4) | | | 30 | 60 | |
| C _{iss} | Input Capacitance | | | 1430 | 2145 | |
| C _{oss} | Output Capacitance | V_{DS} =50V , V_{GS} =0V , F=1MHz | | 215 | 322 | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 8 | 20 | |
| Rg | Gate resistance | V_{GS} =0V , V_{DS} =0V , F=1MHz | | 1.04 | | Ω |

Drain-Source Diode Characteristics and Ratings

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|---------------------------|---|------|------|------|------|
| Is | Continuous Source Current | V _G =V _D =0V , Force Current | | | 48 | Α |
| I _{SM} | Pulsed Source Current | V _G -V _D -0V, Force Current | | | 96 | Α |
| V_{SD} | Diode Forward Voltage | V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C | | | 1 | V |
| trr | Reverse Recovery Time | I _S =5A , dI/dt=100A/us , | | 38 | | nS |
| Qrr | Reverse Recovery Charge | T _J =25°C | | 80 | | nC |

NOTES:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =50V, V_{GS} =10V, L=0.1mH, I_{AS} =48A, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C.
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.





Characteristics Curves

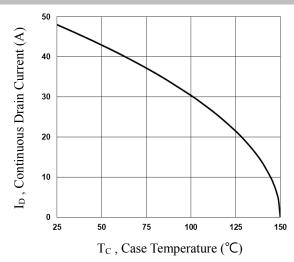


Fig.1 Continuous Drain Current vs. Tc

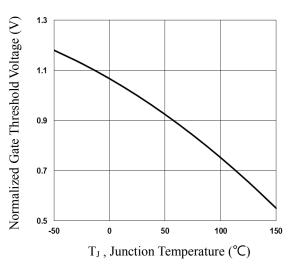


Fig.3 Normalized Vth vs. T_J

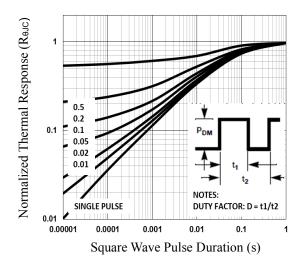


Fig.5 Normalized Transient Impedance

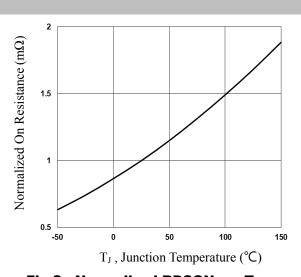


Fig.2 Normalized RDSON vs. T_J

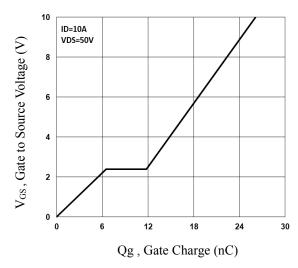


Fig.4 Gate Charge Characteristics

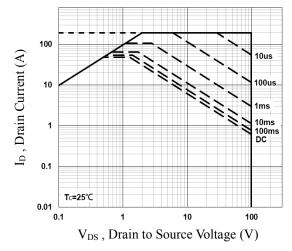
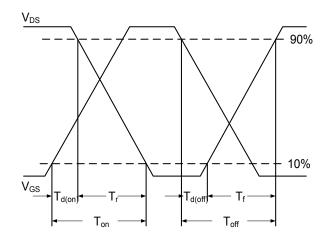


Fig.6 Maximum Safe Operation Area





Characteristics Curves



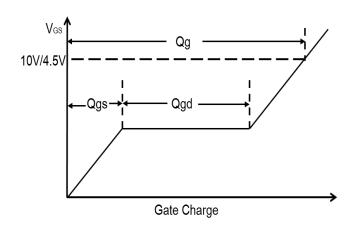
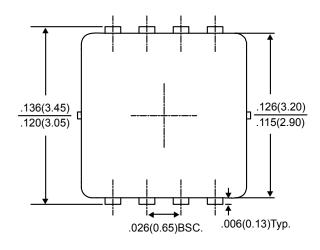
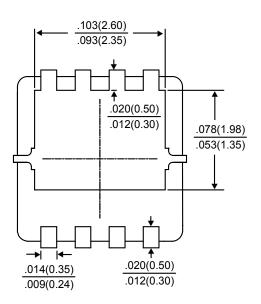


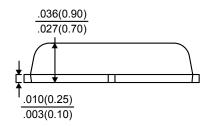
Fig.7 Switching Time Waveform

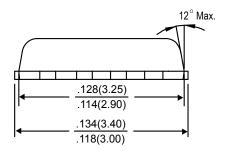
Fig.8 Gate Charge Waveform

Package Outline Dimensions









PPAK3X3

Dimensions in inches and (millimeters)





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